

### Polyphenylene sulfide

FORTRON ICE 504L is a 40% glass fiber reinforced polyphenylene sulfide, that belongs to our new generation of Fortron® PPS.

This new technology allows optimization of molding conditions with faster cycle times. Due to the faster crystallization of the material at a higher temperature, the option of mold wall temperature reduction can be subject of advanced process optimization. The potential for optimization of Fortron® ICE by cycle time reduction is possible by standard cavity surface temperatures of 140 °C. The potential for lowering the mold temperature must be checked individually and it depends on process and part design.

#### **Product information**

Resin Identification Part Marking Code	PPS-GF40 >PPS-GF40<		ISO 1043 ISO 11469
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Rheological properties			
Moulding shrinkage, parallel	0.3	%	ISO 294-4, 2577
Moulding shrinkage, normal	0.6	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	15100	MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min	200	MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	1.9	%	ISO 527-1/-2
Flexural modulus	15000	MPa	ISO 178
Flexural strength	290	MPa	ISO 178
Compressive modulus	15000	MPa	ISO 604
Compressive strength		MPa	ISO 604
Charpy impact strength, 23°C		kJ/m²	ISO 179/1eU
Charpy impact strength, -30 °C		kJ/m <sup>2</sup>	ISO 179/1eU
Charpy notched impact strength, 23°C		kJ/m <sup>2</sup>	ISO 179/1eA
Charpy notched impact strength, -30°C		kJ/m²	ISO 179/1eA
Izod notched impact strength, 23°C		kJ/m <sup>2</sup>	ISO 180/1A
Izod notched impact strength, -30 °C		kJ/m <sup>2</sup>	ISO 180/1A
Izod impact strength, 23°C		kJ/m <sup>2</sup>	ISO 180/1U
Izod impact strength, -30°C		kJ/m²	ISO 180/1U
Hardness, Rockwell, M-scale	100 0.00 <sup>[C]</sup>		ISO 2039-2
Poisson's ratio	0.33 <sup>[C]</sup>		
[C]: Calculated			
Thermal properties			
Melting temperature, 10°C/min	280	°C	ISO 11357-1/-3
Glass transition temperature, 10°C/min	90	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	270	°C	ISO 75-1/-2
Temperature of deflection under load, 8 MPa	215	°C	ISO 75-1/-2
Coefficient of linear thermal expansion (CLTE), parallel	26	E-6/K	ISO 11359-1/-2
Coefficient of linear thermal expansion (CLTE),	42	E-6/K	ISO 11359-1/-2
normal Specific heat capacity of melt	1500	J/(kg K)	ISO 22007-4
opecine near capacity of men	1500		130 22007-4

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### Flammability

Burning Behav. at 1.5mm nom. thickn. Thickness tested Burning Behav. at thickness h Thickness tested Oxygen index Glow Wire Flammability Index, 1.0mm Glow Wire Flammability Index, 2.0mm Glow Wire Ignition Temperature, 1.0mm Glow Wire Ignition Temperature, 2.0mm	V-0 class 1.5 mm V-0 class 0.38 mm 47 % 960 °C 960 °C 825 °C 825 °C	IEC 60695-11-10 IEC 60695-11-10 IEC 60695-11-10 IEC 60695-11-10 ISO 4589-1/-2 IEC 60695-2-12 IEC 60695-2-12 IEC 60695-2-13 IEC 60695-2-13
Electrical properties		
Relative permittivity, 1MHz Dissipation factor, 1MHz Volume resistivity Volume resistivity, at high temperature Temperature	4.1 20 E-4 1E14 <sup>[OT]</sup> Ohm.m 1E10 <sup>[OT]</sup> Ohm.m 220 <sup>[OT]</sup> °C	IEC 62631-2-1 IEC 62631-2-1 IEC 62631-3-1 IEC 62631-3-1
Surface resistivity Surface resistivity, at high temperature	>1E15 Ohm 1E10 <sup>[OT]</sup> Ohm	IEC 62631-3-2 IEC 62631-3-2
Temperature Electric strength, Direct Current Electric strength, DC, high temperature Temperature Comparative tracking index	220 <sup>[OT]</sup> °C 40 <sup>[OT]</sup> kV/mm 27 <sup>[OT]</sup> kV/mm 220 <sup>[OT]</sup> °C 125	IEC 60243-2 IEC 60243-2 IEC 60112
[OT]: One time tested		
Physical/Other properties		
Water absorption, 2mm Density	0.02 % 1650 kg/m³	Sim. to ISO 62 ISO 1183
Injection		
Drying Recommended Drying Temperature Drying Time, Dehumidified Dryer Processing Moisture Content Melt Temperature Optimum Min. melt temperature Max. melt temperature Screw tangential speed Mold Temperature Optimum Min. mould temperature Max. mould temperature Hold pressure range Back pressure Ejection temperature	yes 130 °C 2 - 4 h ≤0.02 % 330 °C 310 °C 340 °C 0.2 - 0.3 m/s 150 °C 140 °C 160 °C 30 - 70 MPa 3 MPa 232 °C	

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#### Characteristics

Additives

Release agent, Nucleated

#### Additional information

Processing Notes

#### **Pre-Drying**

FORTRON should in principle be predried. Because of the necessary low maximum residual moisture content the use of dry air dryers is recommended. The dew point should be =< -  $30^{\circ}$  C. The time between drying and processing should be as short as possible.

#### Storage

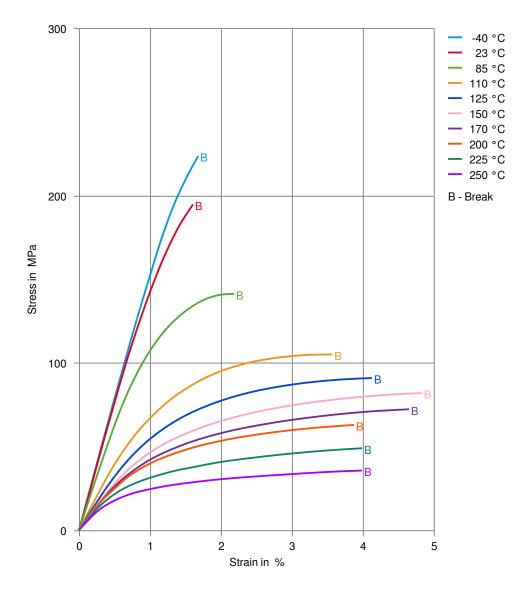
For subsequent storage the material should be stored dry in the dryer until processed ( $\leq 60$  h).

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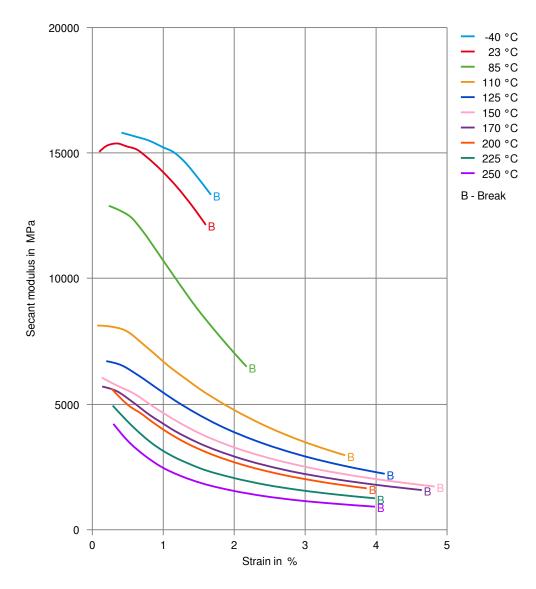
#### Stress-strain





### Polyphenylene sulfide

#### Secant modulus-strain



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NOTICE TO USERS: Values shown are based on testing of laboratory test specimens and represent data that fall within the standard range of properties for natural material. These values alone do not represent a sufficient basis for any part design and are not intended for use in establishing maximum, minimum, or ranges of values for specification purposes. Colourants or other additives may cause significant variations in data values. Properties of moulded parts can be influenced by a wide variety of factors including, but not limited to, material selection, additives, part design, processing conditions and environmental exposure. Other than those products expressly identified as medical grade (including by MT® product designation or otherwise), Celanese's products are not intended for use in medical or dental implants. Regardless of any such product designation, any determination of the suitability of a particular material and part design for any use contemplated by the users and the manner of such use is the sole responsibility of the users, who must assure themselves that the material as subsequently processed meets the needs of their particular product or use. To the best of our knowledge, the information contained in this publication is accurate; however, we do not assume any liability whatsoever for the accuracy and completeness of such information. Contained in this publication is accurate; however, we do not assume any liability of the dusers to investigate whether any existing patents are infringed by the use of the materials mentioned in this publication. Moreover, there is a need to reduce human exposure to many materials to the lowest practical limits in view of possible adverse effects. To the extent that any hazards may have been mentioned in this publication, we neither suggest nor guarantee that such hazards are the only ones that exist. We recommend that persons intending to rely on any recommendation or to use any equipment, processing technique or material industion for handling each material th

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